

*IN THE UNITED STATES PATENT AND TRADEMARK OFFICE*

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In re Patent Application of:  
Kazumi KODAMA, *et al.*

Application No.: 10/578,430

Confirmation No.: 2819

Filed: May 5, 2006

Art Unit: 1796

For: DIP FORMING COMPOSITION AND DIP  
FORMED ARTICLE

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Examiner: Hui CHIN

**AMENDMENT WITH RCE**

**MS RCE**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**INTRODUCTORY COMMENTS**

Responsive to the Office Action of May 29, 2009, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 4 of this paper.